

Evaluation Board for ADG788 Triple SPDT Switch in Chip Scale Package

EVAL-ADG788EBZ

FEATURES

Supply voltage Single: 1.8 V to 5.5 V Dual: ±2.5 V

TTL-/CMOS-compatible control inputs

Switch control options On-board links

External control signals

RoHS compliant

GENERAL DESCRIPTION

This data sheet describes the evaluation board for the ADG788, a triple SPDT switch packaged in a compact 4 mm × 4 mm body, 20-lead LFCSP package. The switches are designed using an enhanced submicron CMOS process to provide optimal performance in terms of on resistance, bandwidth, and power dissipation. The excellent on resistance flatness makes the ADG788 ideal for a wide range of applications, including data and audio-video switching. Each SPDT switch can be individually controlled using a 1-wire parallel interface.

The evaluation board supports both single- and dual-supply operation and comes fitted with connectors that allow the user to evaluate the performance of the ADG788 with minimum effort. The operation of the switches is controlled using the on-board links or by applying external control signals to the appropriate connectors.

The data sheet for the ADG788 device is available from Analog Devices, Inc. It contains all the information regarding operation of the device, and it should be consulted in conjunction with this data sheet when using the evaluation board.

EVALUATION BOARD

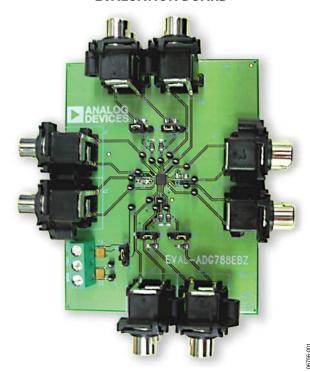


Figure 1.

Rev. 0

Evaluation boards are only intended for device evaluation and not for production purposes. Evaluation boards are supplied "as is" and without warranties of any kind, express, implied, or statutory including, but not limited to, any implied warranty of merchantability or fitness for a particular purpose. No license is granted by implication or otherwise under any patents or other intellectual property by application or use of evaluation boards. Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Analog Devices reserves the right to change devices or specifications at any time without notice. Trademarks and registered trademarks are the property of their respective owners. Evaluation boards are not authorized to be used in life support devices or systems.

EVAL-ADG788EBZ

TABLE OF CONTENTS

Features	1
General Description	1
Evaluation Board	1
Revision History	2
Evaluation Board Hardware	
Power Supply	
Switch Control	

Connections and Test Points	4
Evaluation Board Schematics and Artwork	5
Ordering Information	7
Bill of Materials	7
Ordering Guide	7
ESD Caution	7

REVISION HISTORY

6/07—Revision 0: Initial Version

EVALUATION BOARD HARDWARE

The ADG788 evaluation board kit contains the following:

- A fully fitted printed circuit board
- A CD containing the ADG788 product data sheet and the evaluation board data sheet

The evaluation board allows the user to connect the signals that require switching to the ADG788 switch and control its operation by using the on-board links or by applying the correct control signals to the appropriate connectors. The signals present at the pins of the ADG788 can be monitored using the test point provided on the board.

The following sections describe the function of all connectors and links.

POWER SUPPLY

To operate the ADG788 evaluation board, the user must provide an external power supply connected to Power Block P1. The supply voltage range is $1.8~\rm V$ to $5.5~\rm V$ for single-supply operation and $\pm 2.5~\rm V$ for dual-supply operation. The user can select single-supply operation or dual-supply operation using Link J23, as shown in Table 1.

Table 1. Link J23 Configuration

Position	Operation Mode
Α	Single-supply operation
В	Dual-supply operation (default configuration)

SWITCH CONTROL

The four input pins, IN1, IN2, IN3, and IN4, control the operation of the ADG788. Link J8, Link J9, Link J12, and Link J13 control the logic levels applied to these pins and allow the user to drive these pins with external signals applied to Connector J5 and Connector J11 (the signals have 50 Ω on-board termination resistors to GND). Table 2 describes the configuration achieved for each position of these links.

Table 2. Link J8, Link J9, Link J12, and Link J13 Settings

Link	Position	ADG788 Switch Status				
J8	Removed	S2A to D2 = off, S2B to D2 = on				
	Α					
	B (default configuration)	Controlled via signal applied to Connector J5_TOP	High: S2A to D2 = on, S2B to D2 = off			
			Low: S2A to D2 = off, S2B to D2 = on			
J9	Removed	S3A to D3 = off, S3B to D3 = on				
	Α	S3A to D3 = on, S3B to D3 = off				
	B (default configuration)	Controlled via signal applied to Connector J5_BOTTOM	High: S3A to D3 = on, S3B to D3 = off			
			Low: S3A to D3 = off, S3B to D3 = on			
J12	Removed	S1A to D1 = off, S1B to D1 = on				
	A (default configuration)	Controlled via signal applied to Connector J11_BOTTOM	High: $S1A$ to $D1 = on$, $S1B$ to $D1 = off$			
			Low: S1A to D1 = off, S1B to D1 = on			
	В	S1A to D1 = on, S1B to D1 = off				
J13	Removed	S4A to D4 = off, S4B to D4 = on				
	A (default configuration)	Controlled via signal applied to Connector J11_TOP	High: S4A to D4 = on, S4B to D4 = off			
			Low: S4A to D4 = off, S4B to D4 = on			
	В	S4A to D4 = on, S4B to D4 = off				

EVAL-ADG788EBZ

CONNECTIONS AND TEST POINTS

Table 3.

Connector	Position	Test Point	Connection to ADG788 Pin	
J1	Тор	T19	S1A	
	Bottom	T1	D1	
J2	Тор	T2	S1B	
	Bottom	T3	S2B	
J3	Тор	T4	D2	
	Bottom	T5	S2A	
J4	V_{DD}	T9	V_{DD}	
	GND	T10	GND	
	V _{SS}	T8	V_{SS}	
J5 ¹	Тор	T6	IN2	
	Bottom	T7	IN3	
J6	Тор	T11	S3A	
	Bottom	T12	D3	
J7	Тор	T13	S3B	
	Bottom	T14	S4B	
J10	Тор	T15	D4	
	Bottom	T16	S4A	
J11 ¹	Тор	T17	IN4	
	Bottom	T18	IN1	

¹ This connector is tied to the ADG788 pins only when Link J8 and Link J9 are set in Position B, and J12 and J13 are in Position A.

EVALUATION BOARD SCHEMATICS AND ARTWORK

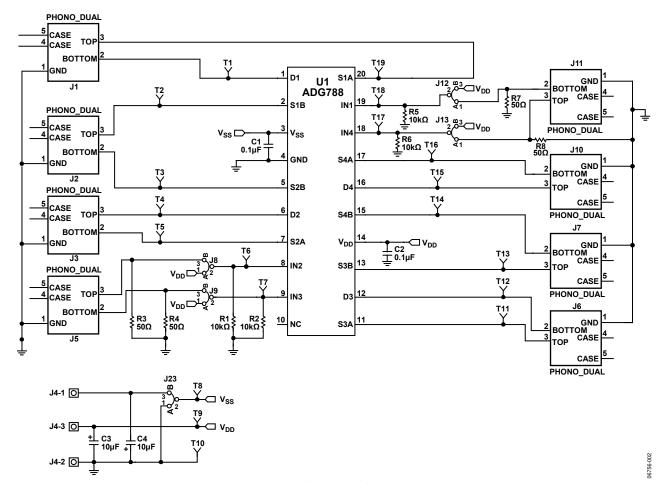


Figure 2. Evaluation Board Schematic

EVAL-ADG788EBZ

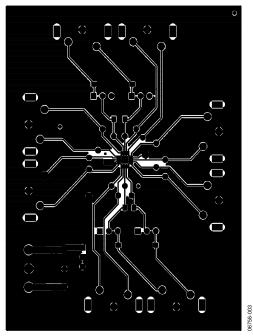


Figure 3. Component Side PCB Drawing (Layer 1)

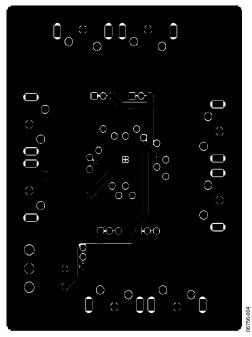


Figure 4. Solder Side PCB Drawing (Layer2) Component Side View

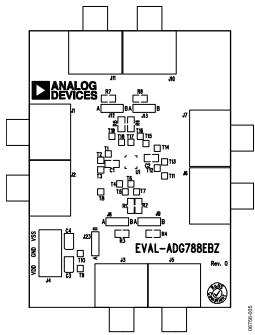


Figure 5. Component Side Silkscreen PCB Drawing

ORDERING INFORMATION

BILL OF MATERIALS

Table 4.

Qty	Reference Designator	Description	Supplier/Number		
2	C1, C2	0.1 μF SMD ceramic capacitor	FEC 301-9482		
2	C3, C4	10 μF (0805 package) 10 V X5R SMD ceramic capacitor	FEC 498-737		
8	J1, J2, J3, J5, J6, J7, J10, J11	Dual phono connector	FEC 128-0670		
1	J4	3-pin power block	FEC 963-2980		
5	J8, J9, J12, J13, J23	3-pin SIL header and shorting link	FEC 486-1220 and FEC 148-029		
4	R1, R2, R5, R6	10 kΩ SMD resistor	FEC 933-0399		
4	R3, R4, R7, R8	50Ω SMD resistor	FEC 933-1336		
19	T1 to T19	Test point	FEC 873-1128		
1	U1	ADG788BCPZ	Analog Devices, Inc.		

ORDERING GUIDE

Model	Package Description				
EVAL-ADG788EBZ ¹	ADG788 Evaluation Board				

¹ Z = RoHS Compliant Part.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

	IΛ	L- <i>[</i>	חו	U.	70	0		D	7
ГV	ш	I - L			או	n		п.	,
┖			۱U	u		u	_	•	_

NOTES

